IR2153(D)(S) & (PbF) NOTE:For new designs, we recommend

IR's new product IRS2153D

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units		
VB	High side floating supply voltage	-0.3	625			
VS	High side floating supply offset voltage		V _B - 25	V _B + 0.3		
V _{HO}	High side floating output voltage		V _S - 0.3	V _B + 0.3	v	
VLO	Low side output voltage		-0.3	V _{CC} + 0.3	V	
V _{RT}	R _T pin voltage		-0.3	V _{CC} + 0.3		
V _{CT}	C _T pin voltage		-0.3	V _{CC} +0.3		
Icc	Supply current (note 1)	—	25	mA		
I _{RT}	R _T pin current	-5	5			
dV _s /dt	Allowable offset voltage slew rate		-50	50	V/ns	
PD	Maximum power dissipation @ $T_A \le +25^{\circ}C$	(8 Lead DIP)	—	1.0	W	
	(8 Lead SOIC)		—	0.625	vv	
RthJA	Rth _{JA} Thermal resistance, junction to ambient (8 Lead DIP)		—	125	°C/W	
	(8 Lead SOIC		_	200	0/00	
Tj	Junction temperature	ture				
TS	Storage temperature	-55	150	°C		
TL	Lead temperature (soldering, 10 seconds)	_	300			

Recommended Operating Conditions

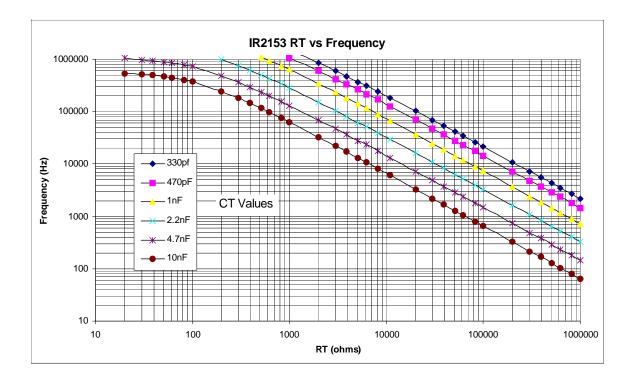
For proper operation the device should be used within the recommended conditions.

Symbol	Definition	Min.	Max.	Units
V _{BS}	High side floating supply voltage	V _{CC} - 0.7	VCLAMP	
Vs	Steady state high side floating supply offset voltage	-3.0 (note 2)	600	V
Vcc	Supply voltage	10	VCLAMP	
lcc	Supply current	(note 3)	5	mA
TJ	Junction temperature	-40	125	°C

- Note 1: This IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the V_{CLAMP} specified in the Electrical Characteristics section.
- Note 2: Care should be taken to avoid output switching conditions where the V_S node flies inductively below ground by more than 5V.
- Note 3: Enough current should be supplied to the V_{CC} pin of the IC to keep the internal 15.6V zener diode clamping the voltage at this pin.

Recommended Component Values

Symbol	Component	Min.	Max.	Units
R _T	Timing resistor value	10	_	kΩ
CT	C _T pin capacitor value	330	_	pF



IR2153(D)(S) & (PbF) NOTE:For new designs, we recommend

Electrical Characteristics

 V_{BIAS} (V_{CC}, V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN}, V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbo	I Definition	Min.	Тур.	Max.	Units	Test Conditions
V _{CCUV+}	Rising V _{CC} undervoltage lockout threshold	8.1	9.0	9.9		
VCCUV-	Falling V _{CC} undervoltage lockout threshold	7.2	8.0	8.8	V	
VCCUVH	V _{CC} undervoltage lockout Hysteresis	0.5	1.0	1.5	1	
IQCCUV	Micropower startup V _{CC} supply current	_	75	150	μΑ	V _{CC} ≤V _{CCUV} -
IQCC	Quiescent V _{CC} supply current		500	950	μ	
VCLAMP	V _{CC} zener clamp voltage	14.4	15.6	16.8	V	$I_{CC} = 5mA$
Floatin	g Supply Characteristics					
Symbo	I Definition	Min.	Тур.	Max.	Units	Test Conditions
IQBSUV	Micropower startup VBS supply current	_	0	10	۵	VCC ≤ VCCUV-
I _{QBS}	Quiescent VBS supply current	—	30	50	μΑ	
VBSMIN	Minimum required V _{BS} voltage for proper	_	4.0	5.0	V	V _{CC} =V _{CCUV+} + 0.1V
	functionality from RT to HO					
I _{LK}	Offset supply leakage current	_	_	50	μΑ	$V_{B} = V_{S} = 600V$
VF	Bootstrap diode forward voltage (IR2153D)	0.5	_	1.2	V	IF = 250mA
	tor I/O Characteristics Definition	Min.	Тур.	Max.	Units	Test Conditions
fosc	Oscillator frequency	19.4	20	20.6		R _T = 36.9kΩ
000		94	100	106	kHz	RT = 7.43kΩ
d	RT pin duty cycle	48	50	52	%	fo < 100kHz
ICT	CT pin current		0.001	1.0	uA	
ICTUV	UV-mode CT pin pulldown current	0.30	0.70	1.2	mA	$V_{CC} = 7V$
Vct+	Upper CT ramp voltage threshold	—	8.0	—		
Vст-	Lower CT ramp voltage threshold	—	4.0	—	V	
VCTSD	CT voltage shutdown threshold	1.8	2.1	2.4		
V _{RT+}	High-level RT output voltage, VCC - VRT		10	50		I _{RT} = 100μA
		—	100	300		I _{RT} = 1mA
Vrt-	Low-level RT output voltage	_	10	50		I _{RT} = 100μA
		_	100	300	mV	$I_{RT} = 1mA$
Vrtuv	UV-mode R _T output voltage		0	100		V _{CC} ≤V _{CCUV} -
VRTSD	SD-Mode RT output voltage, VCC - VRT	_	10	50		I _{RT} = 100μA,
VRISD						
VRISD					4	$V_{CT} = 0V$
VRISD		_	10	300		$V_{CT} = 0V$ $I_{RT} = 1mA,$ $V_{CT} = 0V$

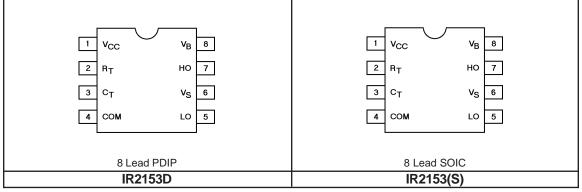
Electrical Characteristics (cont.)

Gate Driver Output Characteristics						
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
VOH	High level output voltage, V _{BIAS} -V _O	—	0	100		I _O = OA
VOL	Low-level output voltage, VO	_	0	100	mV	I _O = OA
VOL_UV	UV-mode output voltage, VO		0	100		I _O = OA
						V _{CC} ≤V _{CCUV} -
tr	Output rise time		80	150		
tf	Output fall time	_	45	100	nsec	
t _{sd}	Shutdown propogation delay	—	660	—	Ī	
td	Output deadtime (HO or LO)	0.75	1.20	1.65	μsec	

Lead Definitions

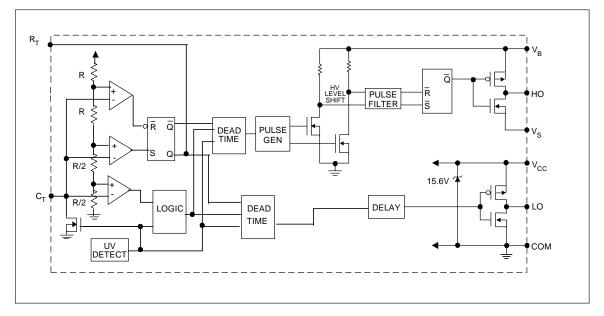
Symbol	Description
Vcc	Logic and internal gate drive supply voltage
R _T	Oscillator timing resistor input
CT	Oscillator timing capacitor input
COM	IC power and signal ground
LO	Low side gate driver output
VS	High voltage floating supply return
НО	High side gate driver output
VB	High side gate driver floating supply

Lead Assignments

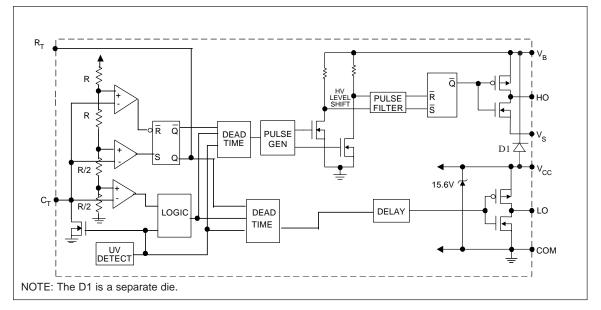


NOTE: The IR2153D is offered in 8 lead PDIP only.

Functional Block Diagram for IR2153(S)



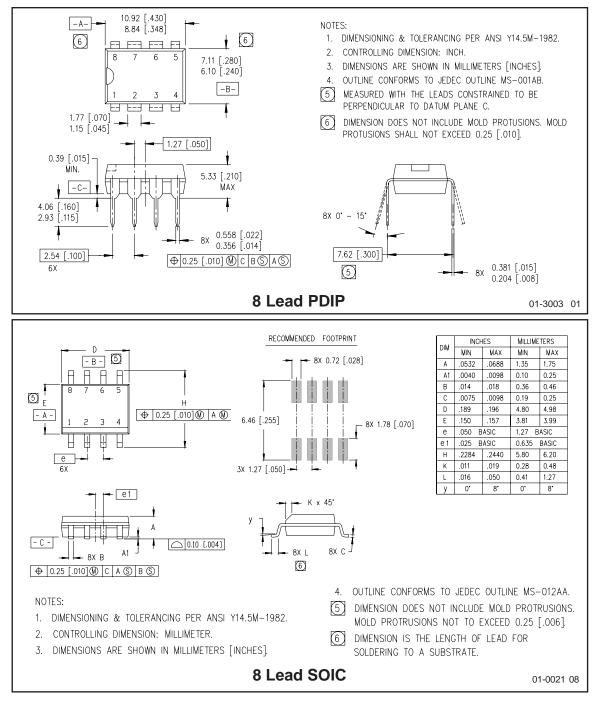
Functional Block Diagram for IR2153D



International

IR2153(D)(S)& (PbF)

NOTE:For new designs, we recommend IR's new product IRS2153D



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IR2153(D)(S) & (PbF) NOTE:For new designs, we recommend IR's new product IRS2153D

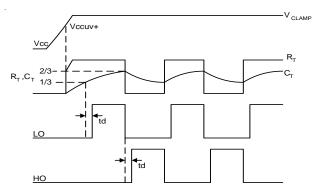


Figure 1. Input/Output Timing Diagram

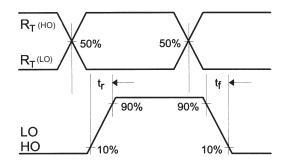


Figure 2. Switching Time Waveform Definitions

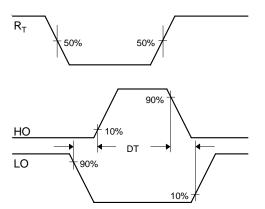
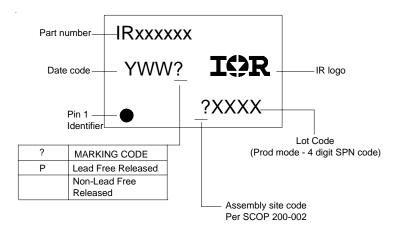


Figure 3. Deadtime Waveform Definitions

LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

Basic Part (Non-Lead Free)

8-Lead PDIP IR2153 order IR2153 8-Lead SOIC IR2153S order IR2153S 8-Lead PDIP IR2153D order IR2153D

Leadfree Part

8-Lead PDIP IR2153 order IR2153PbF 8-Lead SOIC IR2153S order IR2153SPbF 8-Lead PDIP IR2153D order IR2153DPbF

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105 This product has been qualified per industrial level Data and specifications subject to change without notice. 5/21/2020

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